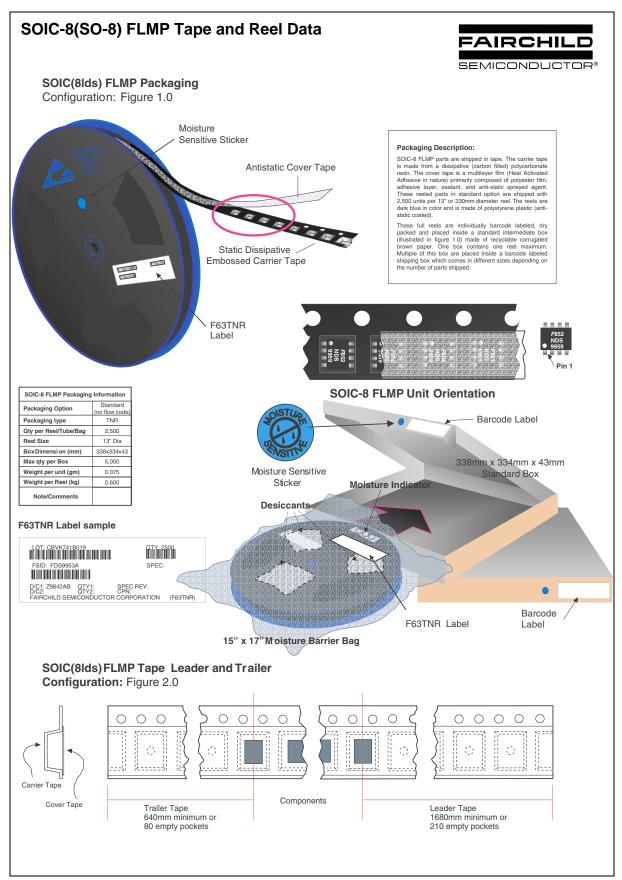
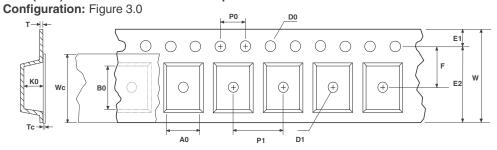
## PLEASE NOTE: FOR DETAILED PACKAGE DIMENSIONS, PLEASE REFER TO THE PRODUCT DATASHEET



## SOIC-8(SO-8) FLMP Tape and Reel Data, continued

## SOIC(8lds) FLMP Embossed Carrier Tape



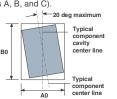
Dimensions are in millimeter														
Pkg type	Α0	В0	w	D0	D1	E1	E2	F	P1	P0	K0	Т	Wc	Тс
SOIC(8lds) (12mm)	6.50 +/-0.10	5.30 +/-0.10	12.0 +/-0.3	1.55 +/-0.05	1.60 +/-0.10	1.75 +/-0.10	10.25 min	5.50 +/-0.05	8.0 +/-0.1	4.0 +/-0.1	2.1 +/-0.10	0.450 +/- 0.150	9.2 +/-0.3	0.06 +/-0.02

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



Sketch A (Side or Front Sectional View)

Component Rotation



Sketch B (Top View)

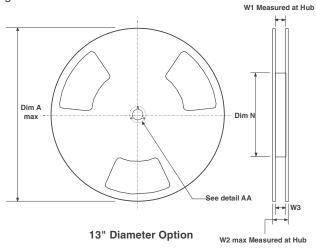
Component Rotation

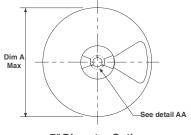


Sketch C (Top View)
Component lateral movement

## SOIC(8lds) FLMP Reel Configuration:







7" Diameter Option

B Min

Dim D

min

Dimensions are in inches and millimeters											
Tape Size	Reel Option Dim A		Dim B Dim C		Dim D Dim N		Dim W1	Dim W2	Dim W3 (LSL-USL)		
12mm	7" Dia	7.00 177.8	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	2.165 55	0.488 +0.078/-0.000 12.4 +2/0	0.724 18.4	0.469 - 0.606 11.9 - 15.4		
12mm	13" Dia	13.00 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	7.00 178	0.488 +0.078/-0.000 12.4 +2/0	0.724 18.4	0.469 - 0.606 11.9 - 15.4		